ABM11-0022-T3



2.0 x 1.6 x 0.55 mm RoHS/RoHS II Compliant MSL Level = N/A

Features

- Reference design for Silabs EFR32 Wireless Gecko Series 2
- Operating Temp Range: $-40 \sim +95$ °C
- Frequency Tolerance @ +25°C: ±8ppm
- Frequency Stability over the Operating Temp. Range (ref. to +25°C): ±13ppm

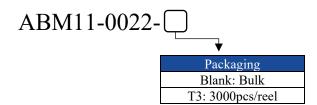
Applications

- Internet of Things (IoT)
- Medical Devices
- Industrial Control & Automation
- Wireless collar
- Glucose Monitor
- LED Lighting

Key Standard Electrical Specifications

Parameters	Minimum	Typical	Maximum	Units	Notes
Frequency	39.000			MHz	
Operation Mode	Fundamental				
Operating Temperature	-40		+95	°C	
Storage Temperature	-40		+95	°C	
Frequency Tolerance @+25°C	-8		+8	ppm	
Frequency Stability over the Operating Temperature (ref. to 25°C)	-13		+13	ppm	
Equivalent series resistance (R1)			35	Ω	
Shunt capacitance (C0)			3.0	pF	
Load capacitance (CL)		10		pF	
Drive Level		10	100	μW	
Aging	-2		+2	ppm	@25°C±3°C First year
Insulation Resistance	500			ΜΩ	$ @ 100 Vdc \pm 15 V $

Options and Part Identification



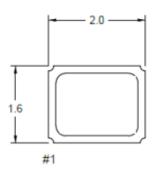


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Mechanical Dimensions

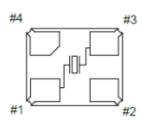


Top View

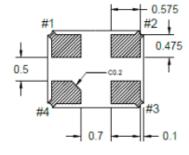


Side View

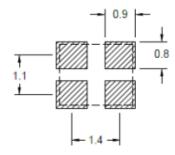




Recommended Land Pattern



Bottom View



Dimensions: mm



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Reflow Profile [JEDEC J-STD-020]

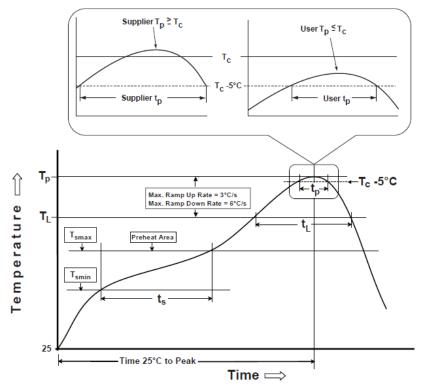


Table 1 SnPb Eutectic Process Classification Temperatures (Tc) Package Thickness Volume mm³ ≥350 <350</td> ≥350 <2.5 mm</td> 235 °C 220 °C ≥2.5 mm 220 °C 220 °C

Table 2							
Pb-Free Process Classification Temperatures (T _c)							
Package Thickness	Volume mm³ <350	Volume mm ³ 350-2000	Volume mm³ >2000				
<1.6 mm	260 °C	260 °C	260 °C				
1.6 mm - 2.5 mm	260 °C	250 °C	245 °C				
. 2 5	250 %C	245 %	245 %				

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat / soak		
Temperature minimum (T _{smin})	100°C	150°C
Temperature maximum (T _{smax})	150°C	200°C
Time (T _{smin} to T _{smax}) (t _s)	60 - 120 sec.	60 - 120 sec.
Average ramp-up rate (T _{smax} to T _P)	3°C/sec. max	3°C/sec. max
Liquidous temperature (T _L)	183°C	217°C
Time at liquidous (t _L)	60 - 150 sec.	60 - 150 sec.
Peak package body temperature (T _P)*	see Table 1	see Table 2
Time (t _p)** within 5°C of the specified classification temperature (T _C)	20 sec.	30 sec.
Ramp-down rate (T _p to T _{smax})	6°C/sec. max	6°C/sec. max
Time 25°C to peak temperature	6 min. max	8 min. max
Reflow cycles	2 max	2 max

^{*}Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.



^{**}Tolerance for time at peak profile temperature (t_p) is defined as supplier minimum and a user maximum.

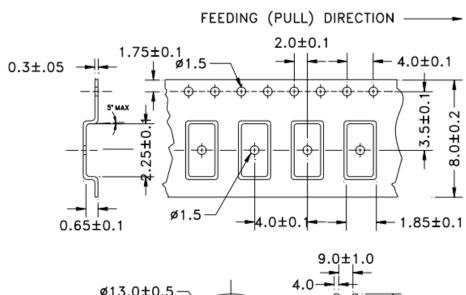
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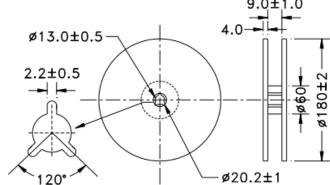


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Packaging

T3: Tape and reel (3,000pcs/reel)





Dimensions: mm

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